

CELANYL® A3 GF50 BK 9005/U CELANYL®

General purpose grade for high mechanical performances.

Product information

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Resin Identification Part Marking Code Continuous Service Temperature	PA66-GF50 >PA66-GF50< 90	°C	ISO 1043 ISO 11469 IEC 60216-1
Rheological properties	dry/cond.	-	
Viscosity number	135/*	cm ³ /g	ISO 307, 1628
Moulding shrinkage range, parallel	0.1 - 0.4	%	ISO 294-4, 2577
Moulding shrinkage range, normal	0.4 - 0.7	%	ISO 294-4, 2577
Typical mechanical properties	dry/cond.		
Tensile modulus	16000/-	MPa	ISO 527-1/-2
Tensile stress at break, 5mm/min	210/-	MPa	ISO 527-1/-2
Tensile strain at break, 5mm/min	2.5/-	%	ISO 527-1/-2
Charpy impact strength, 23°C	N/-	kJ/m ²	ISO 179/1eU
Charpy notched impact strength, 23°C	13/-	kJ/m ²	ISO 179/1eA
Charpy notched impact strength, -30 °C	11.5/-	kJ/m²	ISO 179/1eA
Ball indentation hardness, H 961/30 Poisson's ratio	265/- 0.33/- ^[C]	MPa	ISO 2039-1
[C]: Calculated	0.337-**		
Thermal properties	dr. /oord		
	dry/cond.		
Melting temperature, 10°C/min	260/*	°C	ISO 11357-1/-3
Temperature of deflection under load, 1.8 MPa	245/*	°C °C	ISO 75-1/-2
Temperature of deflection under load, 0.45 MPa	255/*	·U	ISO 75-1/-2
Flammability	dry/cond.		
Burning Behav. at 1.5mm nom. thickn.	HB/*	class	IEC 60695-11-10
Burning Behav. at thickness h	HB/*	class	IEC 60695-11-10
Thickness tested	0.75/*	mm	IEC 60695-11-10
UL recognition	yes/*		UL 94
Electrical properties	dry/cond.		
Volume resistivity	1E13/-	Ohm.m	IEC 62631-3-1
Surface resistivity	*/1E12	Ohm	IEC 62631-3-2
Electric strength	22/-	kV/mm	IEC 60243-1
Comparative tracking index	500/-		IEC 60112
Physical/Other properties	dry/cond.		
Humidity absorption, 2mm	0.9/*	%	Sim. to ISO 62
Water absorption, 2mm	4/*	%	Sim. to ISO 62
Density	1570/-	kg/m³	ISO 1183

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Injection

Drying Recommended	yes
Drying Temperature	80 °C
Drying Time, Dehumidified Dryer	2-4 h
Processing Moisture Content	≤0.15 %
Melt Temperature Optimum	295 °C
Min. melt temperature	285 °C
Max. melt temperature	305 °C
Screw tangential speed	≤0.2 m/s
Mold Temperature Optimum	100 °C
Min. mould temperature	70 °C
Max. mould temperature	120 °C

Characteristics

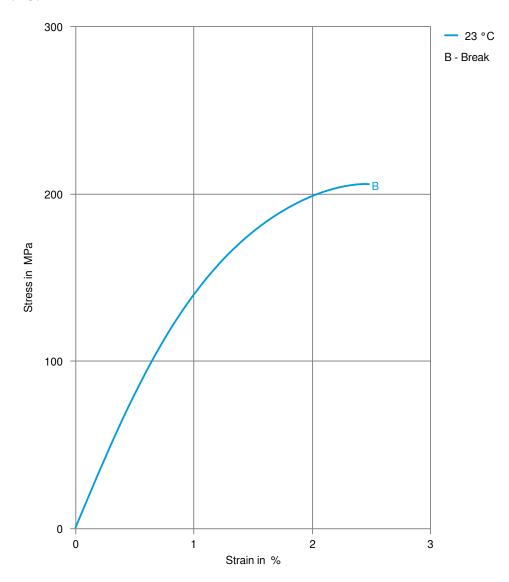
Processing	Injection Moulding
Delivery form	Granules
Special characteristics	High Flow





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Stress-strain (dry)

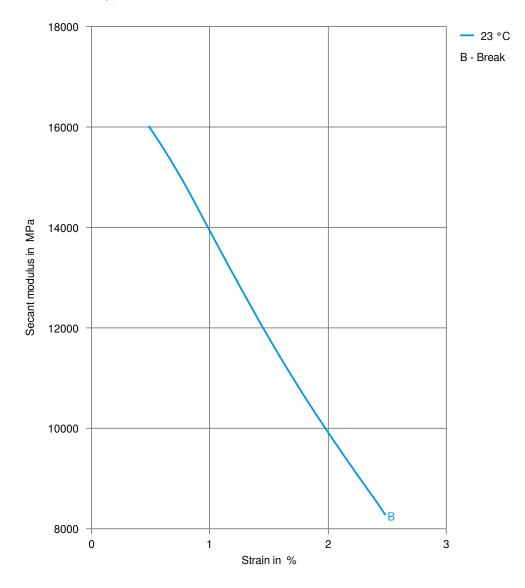






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Secant modulus-strain (dry)



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